IRF740B

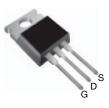


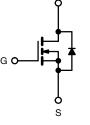
Vishay Siliconix

D Series Power MOSFET

PRODUCT SUMMARY						
V_{DS} (V) at T_{J} max.	450					
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.6				
Q _g max. (nC)	30					
Q _{gs} (nC)	4					
Q _{gd} (nC)	7					
Configuration	Single					

TO-220AB





N-Channel MOSFET

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

APPLICATIONS

- Consumer electronics
 - Displays (LCD or plasma TV)
- Server and telecom power supplies

 SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- Battery chargers

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF740BPbF			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400		
Gate-Source Voltage				± 30	V	
Gate-Source Voltage AC (f > 1 Hz)	V _{GS}	30				
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	۱ _D	10		
	VGS AL TO V	T _C = 100 °C		6	А	
Pulsed Drain Current ^a			I _{DM}	23		
Linear Derating Factor				1.2	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	194	mJ	
Maximum Power Dissipation			PD	147	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		d)//dt	24	V/ns	
Reverse Diode dV/dt ^d			dV/dt	0.6	v/ns	
Soldering Recommendations (Peak temperature) ^c for 10 s				300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 13 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, starting $T_J = 25$ °C.

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PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 62			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.85			0,11			
SPECIFICATIONS ($T_J = 25 \text{ °C}, u$ PARAMETER	SYMBOL		T CONDITI		MIN.	TYP.	MAX.	UNIT
Static	STWDOE	123		0113	IVIIIA.		MAA.	
Drain-Source Breakdown Voltage	V _{DS}	Vaa	= 0 V, I _D = 2	250 µA	400	l _	-	V
V _{DS} Temperature Coefficient	vDs ∆V _{DS} /TJ		to 25 °C, I _I	•	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)			$V_{GS}, I_D = 2$		3	-	5	V/ C
3 ()	V _{GS(th)}		$V_{GS} = \pm 30$		-	-	± 100	-
Gate-Source Leakage	I _{GSS}				-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	-	$V_{DS} = 400 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{\rm DS} = 0.20$ V _{GS} = 10 V		$r_{\rm D} = 5 {\rm A}$	-	0.5	0.6	Ω
Forward Transconductance	9 _{fs}		= 50 V, I _D :	_	-	2.7	-	S
Dynamic	315	.03	се т , . <u></u>	0.11				
Input Capacitance	C _{iss}		<u> </u>			526	-	
Output Capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	59	-	-	
Reverse Transfer Capacitance	C _{rss}			-	9	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 320 V		-	66	-	pF	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	84	-	1	
Total Gate Charge	Qg				-	15	30	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 5 \text{ A}, V_{DS} = 320 \text{ V}$		-	4	-	nC	
Gate-Drain Charge	Q _{gd}				-	7	-	
Turn-On Delay Time	t _{d(on)}				-	12	24	
Rise Time	t _r	Voo -	- 400 V In -	- 10 A	-	18	36	
Turn-Off Delay Time	t _{d(off)}		V _{DD} = 400 V, I _D = 10 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	18	36	ns
Fall Time	t _f	9		-	14	28	1	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.9	1.8	3.6	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	10	A	
Pulsed Diode Forward Current	I _{SM}			-	-	40		
		$T_{J} = 25 \text{ °C}, I_{S} = 5 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V	
Diode Forward Voltage	V _{SD}	1 - 25						
Diode Forward Voltage Reverse Recovery Time	V _{SD}				-	230	-	ns
6	V _{SD} t _{rr} Q _{rr}		5 °C, I _F = I _S 100 A/µs ^{, V} F		-	230 1.6	-	ns µC

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

Document Number: 91519



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

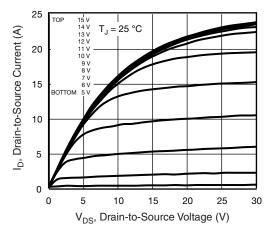


Fig. 1 - Typical Output Characteristics

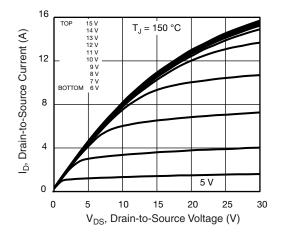


Fig. 2 - Typical Output Characteristics

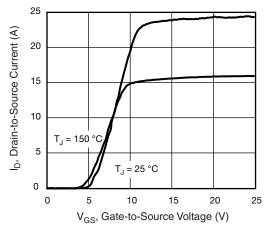


Fig. 3 - Typical Transfer Characteristics

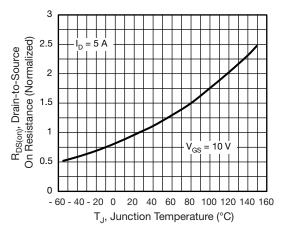


Fig. 4 - Normalized On-Resistance vs. Temperature

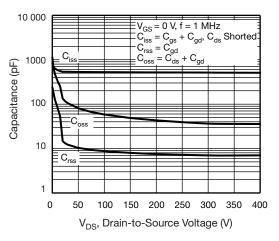
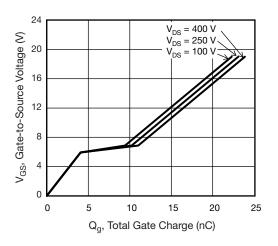


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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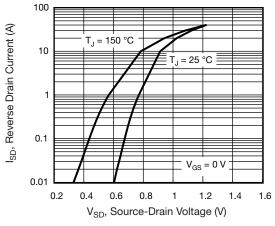
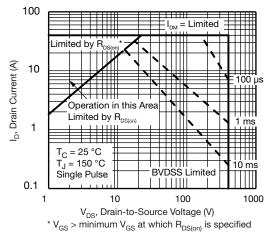
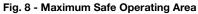


Fig. 7 - Typical Source-Drain Diode Forward Voltage





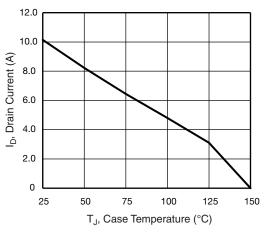


Fig. 9 - Maximum Drain Current vs. Case Temperature

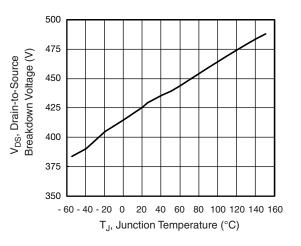
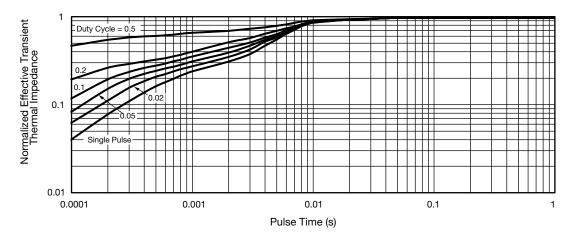


Fig. 10 - Temperature vs. Drain-to-Source Voltage





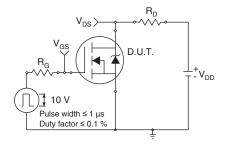
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Fig. 12 - Switching Time Test Circuit

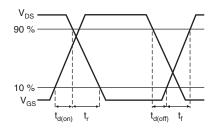


Fig. 13 - Switching Time Waveforms

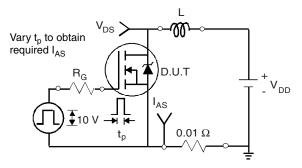


Fig. 14 - Unclamped Inductive Test Circuit

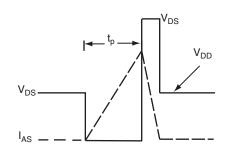


Fig. 15 - Unclamped Inductive Waveforms

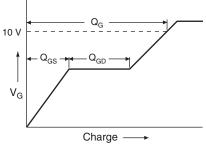


Fig. 16 - Basic Gate Charge Waveform

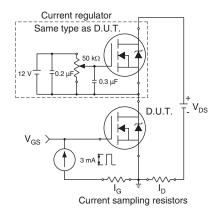


Fig. 17 - Gate Charge Test Circuit

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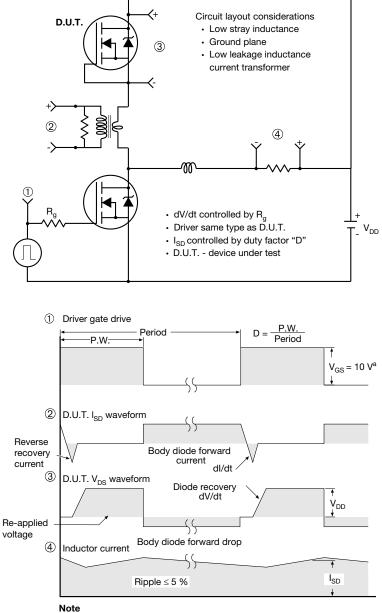
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91519.



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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

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